PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4906664

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
WEI ZHUO	03/28/2018
TIMOTHY DONALD GATHMAN	03/21/2018
WENBANG XU	03/28/2018
LI-CHUNG CHANG	04/04/2018
RUILI	03/30/2018
RAHUL KARMAKER	03/23/2018

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15867206

CORRESPONDENCE DATA

Fax Number: (310)201-5219

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 310.277.7200

Email: Qualcomm-USPTO@seyfarth.com

Correspondent Name: SEYFARTH SHAW LLP

Address Line 1: 2029 CENTURY PARK EAST, SUITE 3500

Address Line 4: LOS ANGELES, CALIFORNIA 90067

173143 ATTORNEY DOCKET NUMBER: JOSEPH LUTZ NAME OF SUBMITTER: SIGNATURE: /Joseph Lutz/ **DATE SIGNED:** 04/09/2018

Total Attachments: 18

PATENT REEL: 045483 FRAME: 0814

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WHEREAS, WE,

- 1. Wei ZHUO, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of San Diego, California
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- 6. Rahul KARMAKER, a citizen of India, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of San Diego, California

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **FILTER CIRCUIT** (collectively the "**INVENTIONS**") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **Qualcomm Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have

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AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

Oone at	LOCATION	on 63/28/18 DATE	Wei ZHUO
Done at _	LOCATION	on DATE	Timothy Donald GATHMAN
Done at _	LOCATION	, on DATE	Wenbang XU
Done at _	LOCATION	on	Li-chung CHANG
Done at	LOCATION	, onDATE	Rui LI
Done at	LOCATION	, on	Rahui KARMAKER

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Done at _	LOCATION	, or	Wei ZHUO
Done at <u>⊊</u>	LOCATION	, on <u>3 (2) /c</u> DATE	Out Timothy Donald GATHMAN
Done at	LOCATION	, onDATE	Wenbang XU
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	LOCATION	·····	DATE	Wei ZHUO
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				·
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	LOCATION		DATE	Wenbang XU
Done at	See Deer	. on	4/4/24/8	I I-chung CHANG
TACHE BE	LOCATION) **** _	4/4/24/8 DATE	Li-chung CHANG
Done at		. on		
Trouv m	LOCATION		DATE	Rui LI
Dona of		an		
Done at	LOCATION	>>> -	DATE	Rahui KARMAKER

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AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

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PATENT REEL: 045483 FRAME: 0833

RECORDED: 04/09/2018